'46A, '47A, 'LS47 feature

- Open-Collector Outputs Drive Indicators Directly
- Lamp-Test Provision
- Leading/Trailing Zero Suppression
- Lamp-Test Provision

'48, 'LS48

feature

Internal Pull-Ups Eliminate

Need for External Resistors

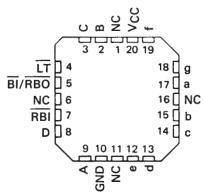
- Leading/Trailing Zero
 Suppression
- SN54LS47, SN54LS48 . . . FK PACKAGE (TOP VIEW)

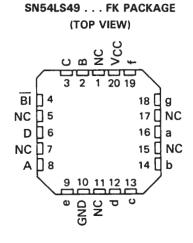
'LS49

feature

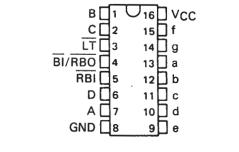
Open-Collector Outputs

Blanking Input





NC - No internal connection



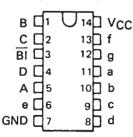
SN5446A, SN5447A, SN54LS47, SN5448, SN54LS48...J PACKAGE

> SN7446A, SN7447A, SN7448...N PACKAGE

SN74LS47, SN74LS48 . . . D OR N PACKAGE

(TOP VIEW)

SN54LS49 . . . J OR W PACKAGE SN74LS49 . . . D OR N PACKAGE (TOP VIEW)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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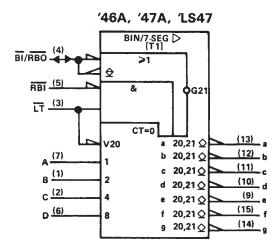
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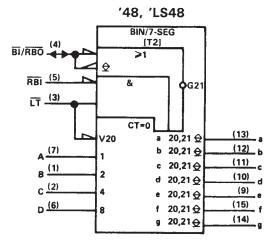
This datasheet has been downloaded from http://www.digchip.com at this page

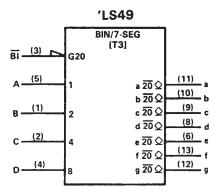
		DRIVER O	UTPUTS		TYPICAL	
TYPE	ACTIVE	OUTPUT	SINK	MAX	POWER	PACKAGES
	LEVEL	CONFIGURATION	CURRENT	VOLTAGE	DISSIPATION	
SN5446A	low	open-collector	40 mA	30 V	320 mW	J, W
SN5447A	low	open-collector	40 mA	15 V	320 mW	J, W
SN5448	high	2-kΩ pull-up	6.4 mA	5.5 V	265 mW	J,W
SN54LS47	low	open-collector	12 mA	15 V	35 mW	J, W
SN54LS48	high	2-kΩ pull-up	2 mA	5.5 V	125 mW	J, W
SN54LS49	high	open-collector	4 mA	5.5 V	40 mW	J, W
SN7446A	low	open-collector	40 mA	30 V	320 mW	J, N
SN7447A	low	open-collector	40 mA	15 V	320 mW	J, N
SN7448	high	2-kΩ pull-up	6.4 mA	5.5 V	265 mW	J, N
SN74LS47	low	open-collector	24 mA	15 V	35 mW	J, N
SN74LS48	high	2-kΩ pull-up	6 mA	5.5 V	125 mW	J, N
SN74LS49	high	open-collector	8 mA	5.5 V	40 mW	J, N

• All Circuit Types Feature Lamp Intensity Modulation Capability

logic symbols[†]







[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.



description

The '46A, '47A, and 'LS47 feature active-low outputs designed for driving common-anode LEDs or incandescent indicators directly. The '48, 'LS48, and 'LS49 feature active-high outputs for driving lamp buffers or common-cathode LEDs. All of the circuits except 'LS49 have full ripple-blanking input/output controls and a lamp test input. The 'LS49 circuit incorporates a direct blanking input. Segment identification and resultant displays are shown below. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions.

The '46A, '47A, '48, 'LS47, and 'LS48 circuits incorporate automatic leading and/or trailing-edge zero-blanking control (\overline{RBI} and \overline{RBO}). Lamp test (\overline{LT}) of these types may be performed at any time when the $\overline{BI}/\overline{RBO}$ node is at a high level. All types (including the '49 and 'LS49) contain an overriding blanking input (\overline{BI}), which can be used to control the lamp intensity by pulsing or to inhibit the outputs. Inputs and outputs are entirely compatible for use with TTL logic outputs.

The SN54246/SN74246 and '247 and the SN54LS247/SN74LS247 and 'LS248 compose the \subseteq and the \subseteq with tails and were designed to offer the designer a choice between two indicator fonts.





SEGMENT

DECIMAL OR			INP	JTS			BI/RBO†			0	UTPUI	S			NOTE
FUNCTION	LT	RBI	D	с	в	Α		а	ь	c	d	е	f	g	
0	н	н	L	L	L	L	н	ON	ON	ON	ON	ON	ON	OFF	
1	н	х	L	L	Ł	н	н	OFF	ON	ON	OFF	OFF	OFF	OFF	
2	н	x	L	L	н	L	н	ON	ON	OFF	ON	ON	OFF	ON	
3	н	х	L	L	н	н	н	ON	ON	ON	ON	OFF	OFF	ON	
4	н	X	L	н	L	L	н	OFF	ON	ON	OFF	OFF	ON	ON	
5	н	x	L	н	L	н	н	ON	OFF	ON	ON	OFF	ON	ON	
6	н	X	L	н	н	Ĺ	н	OFF	OFF	ON	ON	ON	ON	ON	
7	н	X	L	н	н	н	н	ON	ON	ON	OFF	OFF	OFF	OFF	1
8	н	X	н	L	L	L	н	ON	ON	ON	ON	ON	ON	ON	
9	н	x	н	L	L	н	н	ON	ON	ON	OFF	OFF	ON	ON	
10	н	x	н	L	н	L	н	OFF	OFF	OFF	ON	ON	OFF	ON	
11	н	x	н	L	н	н	н	OFF	OFF	ON	ON	OFF	OFF	ON	
12	н	X	н	н	L	L	н	OFF	ON	OFF	OFF	OFF	ON	ON	
13	н	X	н	н	L	н	н	ON	OFF	OFF	ON	OFF	ON	ON	
14	н	x	н	н	н	L	н	OFF	OFF	OFF	ON	ON	ON	ON	1
15	н	x	н	н	н	н	н	OFF	OFF	OFF	OFF	OFF	OFF	OFF	
81	×	X	X	х	х	x	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	2
RBI	н	L	L	L	L	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	3
LT	L	x	x	х	х	х	н	ON	ON	ON	ON	ON	ON	ON	4

'46A, '47A, 'LS47 FUNCTION TABLE (T1)

H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple blanking input (RBI) must be open or high if blanking of a decimal zero is not desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are off regardless of the level of any other input.

3. When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp test input high, all segment outputs go off and the ripple-blanking output (RBO) goes to a low level (response condition).

4. When the blanking input/ripple blanking output (BI/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are on.

 $^{\dagger}\overline{\text{BI}/\text{RBO}}$ is wire AND logic serving as blanking input ($\overline{\text{BI}}$) and/or ripple-blanking output ($\overline{\text{RBO}}$).



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												_			
DECIMAL OR			INPL	JTS			BI/RBO†			οι	JTPU'	rs			NOTE
FUNCTION	LT	RBI	D	С	В	A		а	b	с	d	e	f	g	
0	н	н	L	L	L,	L	н	H	Н	н	Н	н	н	L	
1	н	X	L	L	L	н	н	L	н	н	L	L	L	L	
2	н	X	L	L	н	L	н	н	н	L	н	н	L	н	
3	н	X	L	L	н	н	н	Н	н	н	Н	L	L	н	
4	н	X	L	н	L	L	Н	L	н	н	L	L	Н	н	
5	н	X	L	н	L	н	н	н	L	н	н	L	н	H	
6	н	X	L	н	н	L	н	L	L	н	н	н	н	н	
7	н	X	L	н	н	H	н	Н	н	Н	L	L	L	L	1
8	н	X	н	L	L	L	н	н	Н	Н	Н	H	н	н	•
9	Н	X	н	L	L	н	н	н	н	н	L	L	н	н	
10	н	X	н	L	н	L	н	L	L	L	н	н	L	н	
11	н	X	н	L	н	H	н	L	L	Н	н	L	L	Н	
12	Н	X	н	Н	L	L	н	L	Н	L	L	L	н	н	
13	н	X	H	н	L	н	н	н	L	L	н	L	н	н	
14	н	X	н	н	н	L	н	L	L	L	н	н	н	н	
15	н	X	H.	н	н	н	н	L	L	L	L	L	L	L	
BI	X	X	X	Х	Х	Х	L	L	L	L	L	L	L	L	2
RBI	н	L	L .	L	L	L	L L	L	L	L	L	L	L	L	3
LT	L	X	X	х	х	х	н	н	н	Н	H	Н	Н	н	4

'48, 'LS48 FUNCTION TABLE (T2)

H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input (RBI) must be open or high, if blanking of a decimal zero is not desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are low regardless of the level of any other input.

3. When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp-test input high, all segment outputs go low and the ripple-blanking output (RBO) goes to a low level (response condition).

4. When the blanking input/ripple-blanking output (BI/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are high.

+BI/RBO is wire-AND logic serving as blanking input (\overline{BI}) and/or ripple-blanking output (\overline{RBO}).

				FUN	стю	N TA	BLE	(T3)					
DECIMAL		11	IPUT	s				οι	JTPU	тѕ			NOTE
FUNCTION	D	С	в	Α	BĪ	а	b	С	d	е	f	g	
0	L	L	L	L	н	н	Н	Н	Н	Н	н	L	
1	L	L	L	н	H	L	Н	н	L	L	L	L	
2	L	L	н	L	н	н	н	L	н	н	L	н	
3	L	L	н	н	н	н	н	Н	Н	L	L	H	
4	L	Н	L	L	н	L	Н	Н	L	L	н	н	
5	L	н	Ł	н	н	н	L	н	H	L	Н	н	
6	L	н	н	L	н	L	L	н	н	Н	н	н	
7	L	Н	H	н	Н	н	<u> </u>	<u> </u>	L	L	L	<u> </u>	1
8	н	L	L	Ľ	н	н	н	н	н	н	н	н	
9	н	L	L	н	н	н	н	н	L	L	н	н	
10	н	L	н	L	н	L	L	L	н	н	L	Н	
11	н	L	H	H	н	L	L	<u></u> H	<u> </u>	L	L	Н	
12	н	Н	Ł	L	н	L L	н	L	Ł	L	н	н	
13	н	н	L	н	н	н	L	L	н	L	н	н	
14	н	н	н	L	н	L	L	L	н	н	н	Н	
15	н	н	н	н	Н	L_			<u> </u>	_L	L	<u> </u>	
BI	X	Х	X	Х	L	L	L	L	<u> </u>	L	L		2

'LS49 NOTION TABLE (T2)

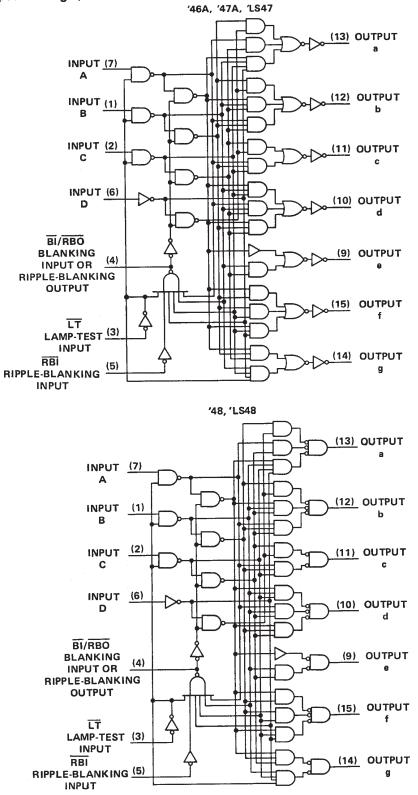
H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are low regardless of the level of any other input.

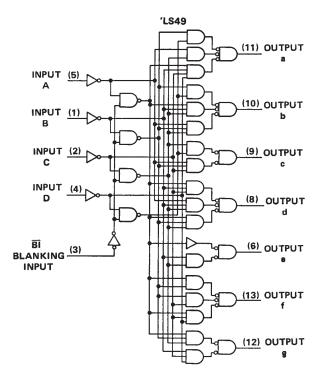


logic diagrams (positive logic)



Pin numbers shown are for D, J, N, and W packages.

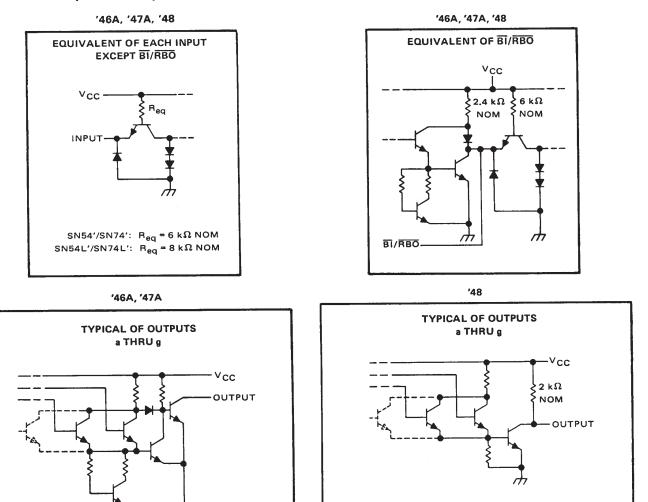
logic diagrams (continued)



Pin numbers shown are for D, J, N, and W packages.



schematics of inputs and outputs



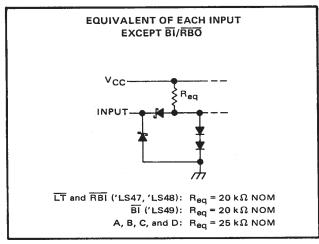
A



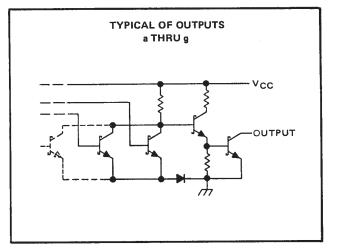
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schematics of inputs and outputs

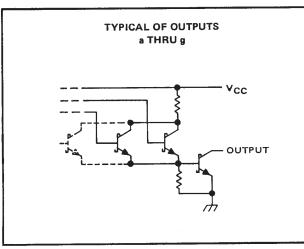
'LS47, 'LS48, 'LS49



'LS47



'LS49







BI/RBO

'LS47, 'LS48, 'LS49

EQUIVALENT OF BI/RBO

20 kΩ

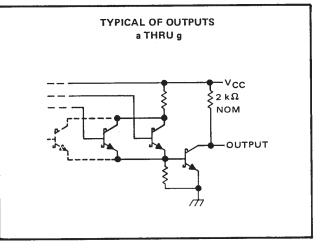
NOM

Vcc

10 kΩ

NOM

'LS48



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	
Input voltage	
Operating free-air temperature range: SN5446A, SN5447A	
Storage temperature range	$-65^{\circ}C$ to $150^{\circ}C$

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		5	SN5446A			SN5447A			N7446	Α	5	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.5	5	5.5	4.75	5	5.25	4.75	5	5.25	V
Off-state output voltage, VO(off)	a thru g			30			15			30			15	V
On-state output current, IO(on)	a thru g			40			40			40			40	mA
High-level output current, IOH	BI/RBO			-200			-200			-200			-200	μA
Low-level output current, IOL	BI/RBO			8			8			8			8	mA
Operating free-air temperature, T	4	-55		125	-55		125	0		70	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDIT	TIONS [†]	MIN	TYP‡	MAX	UNIT
⊻ін	High-level input voltage				2			V
VIL	Low-level input voltage						0.8	V
VIK	Input clamp voltage		V _{CC} = MIN, I _I =	—12 mA			-1.5	V
VOH	High-level output voltage	BI/RBO	V _{CC} = MIN, V _{IH} V _{IL} = 0.8 V, I _{OH}		2.4	3.7		v
VOL	Low-level output voltage	BI/RBO	V _{CC} = MIN, V _{IH} V _{IL} = 0.8 V, I _{OL}	1		0.27	0.4	v
IO(off)	Off-state output current	a thru g	V _{CC} = MAX, V _{IH} V _{IL} = 0.8 V, V _O (250	μA
V _{O(on)}	On-state output voltage	a thru g	V _{CC} = MIN, V _{IH} V _{IL} = 0.8 V, I _O (c			0.3	0.4	v
ų į	Input current at maximum input voltage	Any input except BI/RBO	V _{CC} = MAX, V _i =	= 5.5 V			1	mA
¹ ІН	High-level input current	Any input except BI/RBO	V _{CC} = MAX, V ₁ =	= 2.4 V			40	μA
μL	Low-level input current	Any input except BI/RBO	V _{CC} = MAX, VI =	= 0.4 V			-1.6	mA
		BI/RBO]				4	
los	Short-circuit output current	BI/RBO	V _{CC} = MAX				-4	mA
ICC	Supply current		V _{CC} = MAX, See Note 2	SN54' SN74'		64 64	85 103	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
toff	Turn-off time from A input			100	ns
ton	Turn-on time from A input	$C_{L} = 15 \text{pF}, R_{L} = 120 \Omega,$		100	113
toff	Turn-off time from RBI input	See Note 3		100	ns
ton	Turn-on time from RBI input			100	113

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)				 							7V
Input voltage				 							5.5 V
Operating free-air temperature range: SN	N5448			 							–55°C to 125°C
SN	N7448			 							$ 0^{\circ}C \text{ to } 70^{\circ}C$
Storage temperature range		 •	•	 •	•	 •	 •	•	•••	•	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5448	3		UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
	a thru g			-400			-400	μA
High-level output current, IOH	BI/RBO			-200			200	<u> </u>
	a thru g			6.4			6.4	mA
Low-level output current, IOL	BI/RBO	1		8			8	
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONS	MIN	TYP‡	MAX	UNIT
⊻ін	High-level input voltage				2			V
VIL	Low-level input voltage						0.8	V
VIK	Input clamp voltage		V _{CC} = MIN, I	= -12 mA			-1.5	V
VOH	High-level output voltage	a thru g BI/RBO	V _{CC} = MIN, V V _{II} = 0.8 V, I _C		2.4 2.4	4.2		v
10	Output current	a thru g	V _{CC} = MIN, V Input conditions	o = 0.85 V,	-1.3	2		mA
VOL	Low-level output voltage	• • • • • • • • • • • • • • • •	V _{CC} = MIN, V V _{IL} = 0.8 V, I _C			0.27	0.4	v
ų	Input current at maximum input voltage	Any input except BI/RBO	V _{CC} = MAX, V	i = 5.5 V			1	mA
Чн	High-level input current	Any input except BI/RBO	V _{CC} = MAX, V	′ _I = 2.4 ∨			40	μA
ηĽ	Low-level input current	Any input except BI/RBO BI/RBO	V _{CC} = MAX, V	′I = 0.4 V			-1.6	mA
los	Short-circuit output current	BI/RBO	V _{CC} = MAX				-4	
lcc	Supply current	•	V _{CC} = MAX, See Note 2	SN5448 SN7448		53 53	76 90	-l mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

NOTE 2: ICC is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25 °C$

PARAMETER	TEST CONDITIONS	MIN	түр	MAX	UNIT
^t PHL Propagation delay time, high-to-low-level output from A input				100	ns
tPLH Propagation delay time, low-to-high-level output from A input	$C_{L} = 15 \text{ pF}, R_{L} = 1 \text{ k}\Omega$			100	
tPHL Propagation delay time, high-to-low-level output from RBI input	See Note 3			100	ns
^t PLH Propagation delay time, low-to-high-level output from RBI input				100	



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	· · · · · · · · · · · · · · · · · · ·
Input voltage	
Current forced into any output in the off state	
Operating free-air temperature range: SN54LS47	
SN74LS47	$ 0^{\circ}C to 70^{\circ}C$
Storage temperature range	\cdots -65° C to 150° C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		S	N54LS4	17	S	N74LS4	17	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
Off-state output voltage, VO(off)	a thru g			15			15	V
On-state output current, IO(on)	a thru g			12			24	mA
High-level output current, IOH	BI/RBO			-50			-50	μA
Low-level output current, IOL	BI/RBO			1.6			3.2	mA
Operating free-air temperature, T _A		-55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					S	17					
	PARAMETER		TEST CON	IDITIONS [†]	MIN	N54LS4	MAX	MIN	TYP	MAX	UNIT
VIH	High-level input voltage				2			2			v
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	I _I =18 mA			-1.5			-1.5	V
v _{он}	High-level output voltage	BI/RBO	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -50 μA	2.4	4.2		2.4	4.2		v
VOL	Low-level output voltage	BI/RBO	V _{CC} = MIN, V _{IH} = 2 V,	l _{OL} = 1.6 mA		0.25	0.4		0.25	0.4	v
-01	_on or output for togo	51,1100	VIL = VIL max	I _{OL} = 3.2 mA					0.35	0.5	
lO(off)	Off-state output current	a thru g	V _{CC} = MAX, V _{IL} = V _{IL} max,	V _{IH} = 2 V, V _{O(off)} = 15 V			250			250	μA
V _{O(on)}	On-state output voltage	a thru q	V _{CC} = MIN, V _{IH} = 2 V,	l _{O(on)} = 12 mA		0.25	0.4		0.25	0.4	v
0(01)			VIL = VIL max	¹ O(on) = 24 mA					0.35	0.5	
li –	Input current at maximur	n input voltage	V _{CC} = MAX,	V _I = 7 V			0.1			0.1	mA
ЦН	High-level input current		V _{CC} = MAX,	V _I = 2.7 V			20			20	μA
կլ	Low-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 0.4 V			-0.4			-0.4	mA
		BI/RBO					-1.2			-1.2	
IOS	Short-circuit output current	BI/RBO	V _{CC} = MAX		-0.3		-2	-0.3		-2	mA
ICC	Supply current		V _{CC} = MAX,	See Note 2		7	13		7	13	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V. switching characteristics, $V_{CC} = 5 V$, $T_A = 25 °C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
toff	Turn-off time from A input				100	
ton	Turn-on time from A input	$C_{L} = 15 \text{ pF}, \text{ R}_{L} = 665 \Omega,$			100	ns
toff	Turn-off time from RBI input, outputs (a-f) only	See Note 3			100	
ton	Turn-on time from RBI input, outputs (a-f) only				100	ns



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	 7 V
Input voltage	 1 V
Operating free-air temperature range: SN54LS48	 5°C
SN74LS48	 JC
	 °C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		s	N54LS4	18	S	ТИИ		
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
	a thru g			-100			-100	μA
igh-level output current, 1 _{OH}	BI/RBO			-50			-50	μ <i>μ</i> Α
······································	a thru g			2			6	mA
ow-level output current, IOL	BI/RBO			1.6			3.2	
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				DITIONIST	S	N54LS4	8	S	UNIT		
	PARAMETER		TEST CON	DITIONS	MIN	түр‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage		1		2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	l ₁ = -18 mA			-1.5			-1.5	V
V _{OH}	High-level output voltage	a thru g and BI/RBO	V _{CC} = MIN, V _{IL} = V _{IL} max,	••••	2.4	4.2		2.4	4.2		v
۱ ₀	Output current	a thru g	V _{CC} = MIN, Input conditions	$V_{O} = 0.85 V$, as for V_{OH}	-1.3	-2	-	-1.3	-2		mA
		a thru a	$V_{CC} = MIN,$	1 _{0L} = 2 mA		0.25	0.4		0.25	0.4	v
N.		a thru g	V _{IH} = 2 V, V _{IL} = V _{IL} max	IOL = 6 mA					0.35	0.5	
VOL	Low-level output voltage	BI/RBO	$V_{CC} = MIN,$	I _{OL} = 1.6 mA		0.25	0.4		0.25	0.4	v
		ыльо	V _{IH} = 2 V, V _{IL} = V _{IL} max	I _{OL} = 3.2 mA					0.35	0.5	
4	Input current at maximum input voltage	Any input except BI/BRO	V _{CC} = MAX,	V ₁ = 7 V			0.1			0.1	mA
ін	High-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 2.7 V			20			20	μA
μL	Low-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 0.4 V			-0.4			-0.4	mA
•-		BI/RBÔ					-1.2			-1.2]
IOS	Short-circuit output current	BI/RBO	V _{CC} = MAX		-0.3		-2	-0.3		-2	mA
1cc	Supply current	-	V _{CC} = MAX,	See Note 2		25	38		25	38	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A 25°C.

NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics,	$V_{CC} = \xi$	5V,	TΑ	= 25°C
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PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
^t PHL Propagation delay time, high-to-low-level output from A input	$C_{L} = 15 \text{ pF}, R_{L} = 4 \text{ k}\Omega,$			100	ns
tpLH Propagation delay time, low-to-high-level output from A input	See Note 3			100	113
tPHL Propagation delay time, high-to-low-level output (a-f only) from RBI input	$C_{L} = 15 \text{ pF}, \text{ R}_{L} = 6 \text{ k}\Omega,$			100	ns
tPLH Propagation delay time, low-to-high-level output (a-f only) from RBI input	opagation delay time, low-to-high-level output (a-f only) from RBI input See Note 3			100	



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)											 								7 V
Input voltage											 								7 V
Current forced into any output in the off state											 							•	1 mA
Operating free-air temperature range: SN541 S49											 				!	55°	´C t	to 1	125°C
SN741 S49				-							 						JC	το	
Storage temperature range	•	•	-	•	•	•	-	•	-	-	 	-			-6	55	Ct	01	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	s	N54LS	19	s	UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	0
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output voltage, V _{OH}			5.5			5.5	V
Low-level output current, IOL			4			8	mA
Operating free-air temperature, T _A	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST COM	DITIONS	S	N54LS4	9	S	N74LS4	19	
		TEST COM	ADITION2,	MIN	ТҮР‡	MAX	MIN	түр‡	MAX	UNIT
VIH	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.7			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	l _l = -18 mA			-1.5			-1.5	V
юн	High-level output current	V _{CC} = MIN, V _{1L} = V _{1L} max,	V _{IH} = 2 V, V _{OH} = 5.5 V			250			250	μА
VOL	Low-level output voltage	$V_{CC} = MIN,$ $V_{IH} = 2 V,$	IOL = 4 mA		0.25	0.4		0.25	0.4	V
		Vil = Vil max	1 _{0L} = 8 mA	-				0.35	0.5] `
Ц	Input current at maximum input voltage	V _{CC} = MAX,	V1 = 7 V			0.1			0.1	mA
ιн	High-level input current	V _{CC} = MAX,	VI = 2.7 V			20			20	μA
11L	Low-level input current	V _{CC} = MAX,	V1 = 0.4 V			-0.4			-0.4	mA
lcc	Supply current	V _{CC} = MAX,	See Note 2		8	15		8	15	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25 °C$

PARAMETER	TEST CONDITIONS	MIN T	YP MAX	UNIT
tPHL Propagation delay time, high-to-low-level output from A input	$C_{L} = 15 \text{ pF}, R_{L} = 4 \text{ k}\Omega,$		100	
tPLH Propagation delay time, low-to-high-level output from A input	See Note 3		100	ns
tPHL Propagation delay time, high-to-low-level output (a-f only) from RBI input	$C_{L} = 15 pF, R_{L} = 6 k\Omega,$		100	
tPLH Propagation delay time, low-to-high-level output (a-f only) from RBI input	See Note 3		100	ns



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